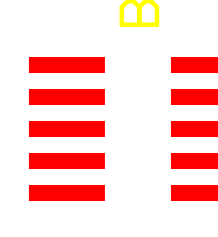
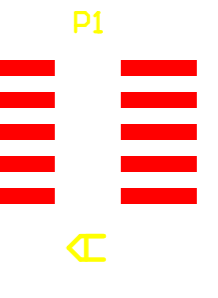
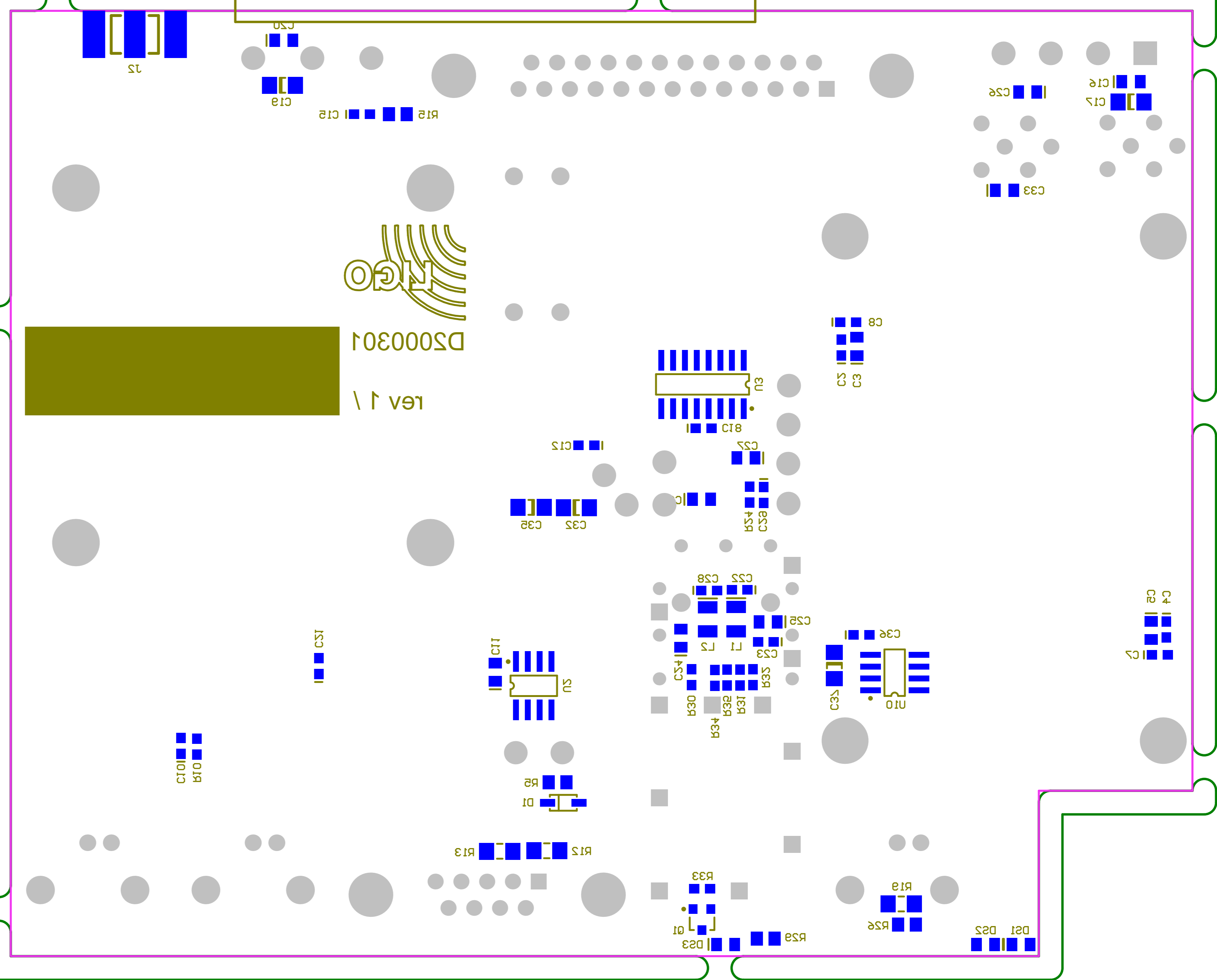
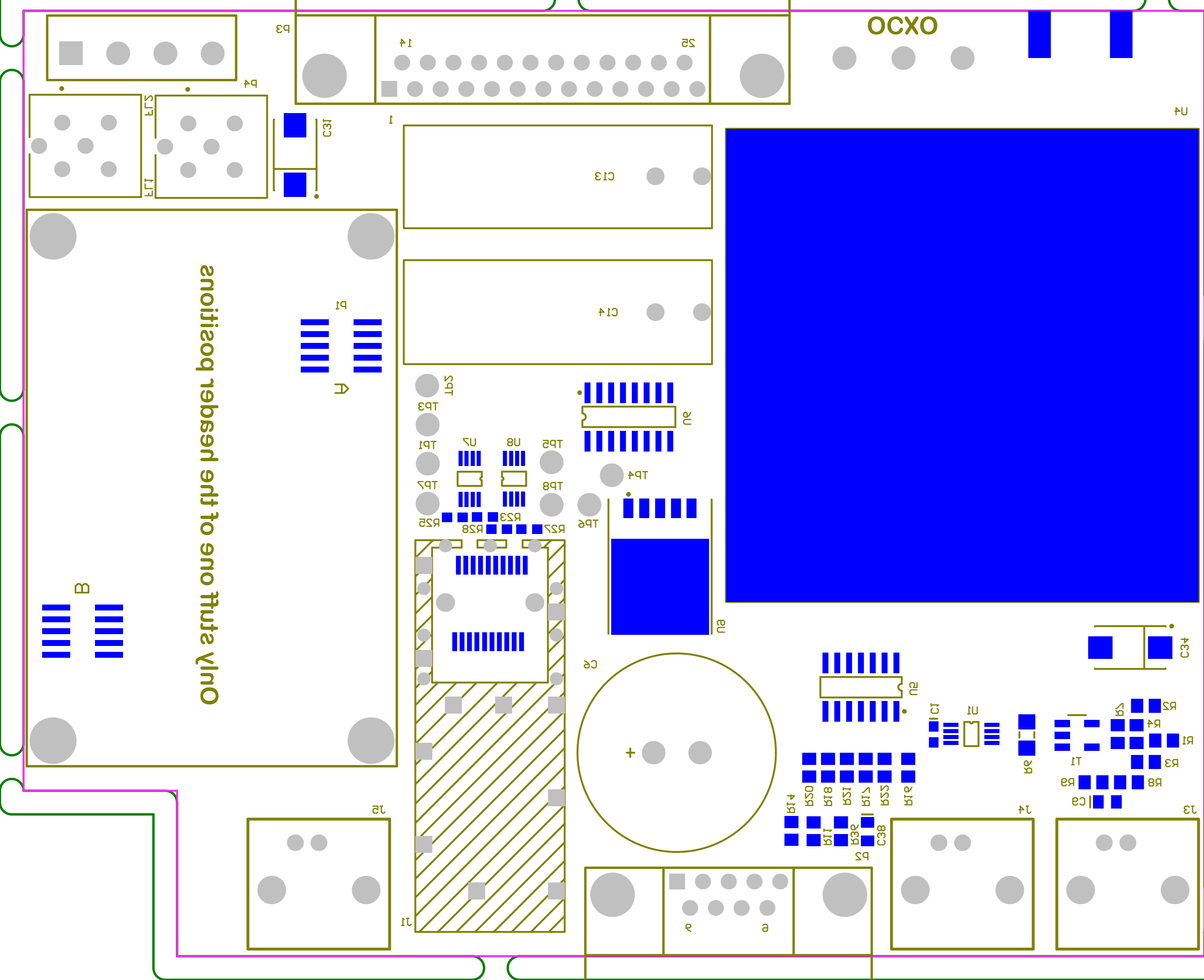
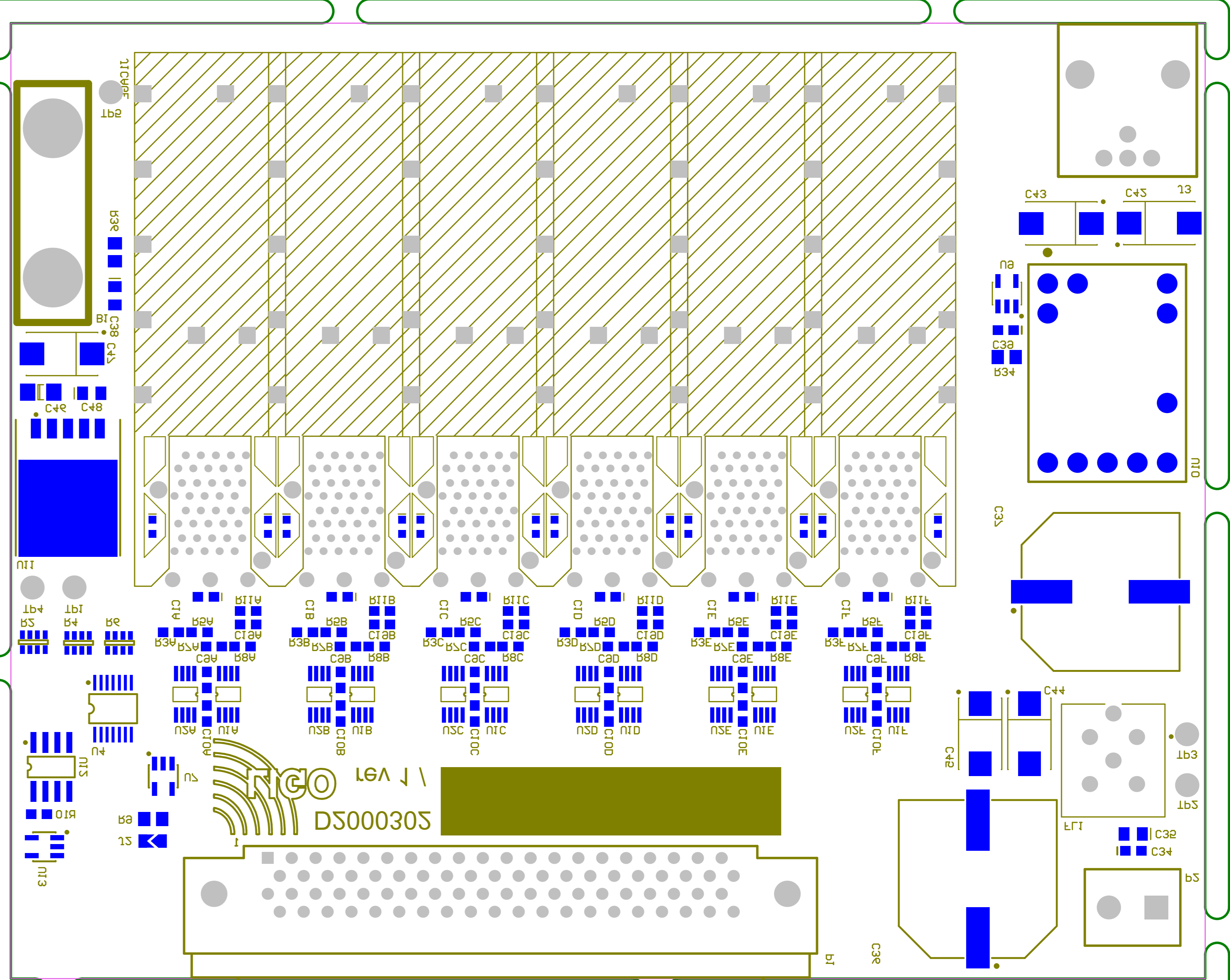
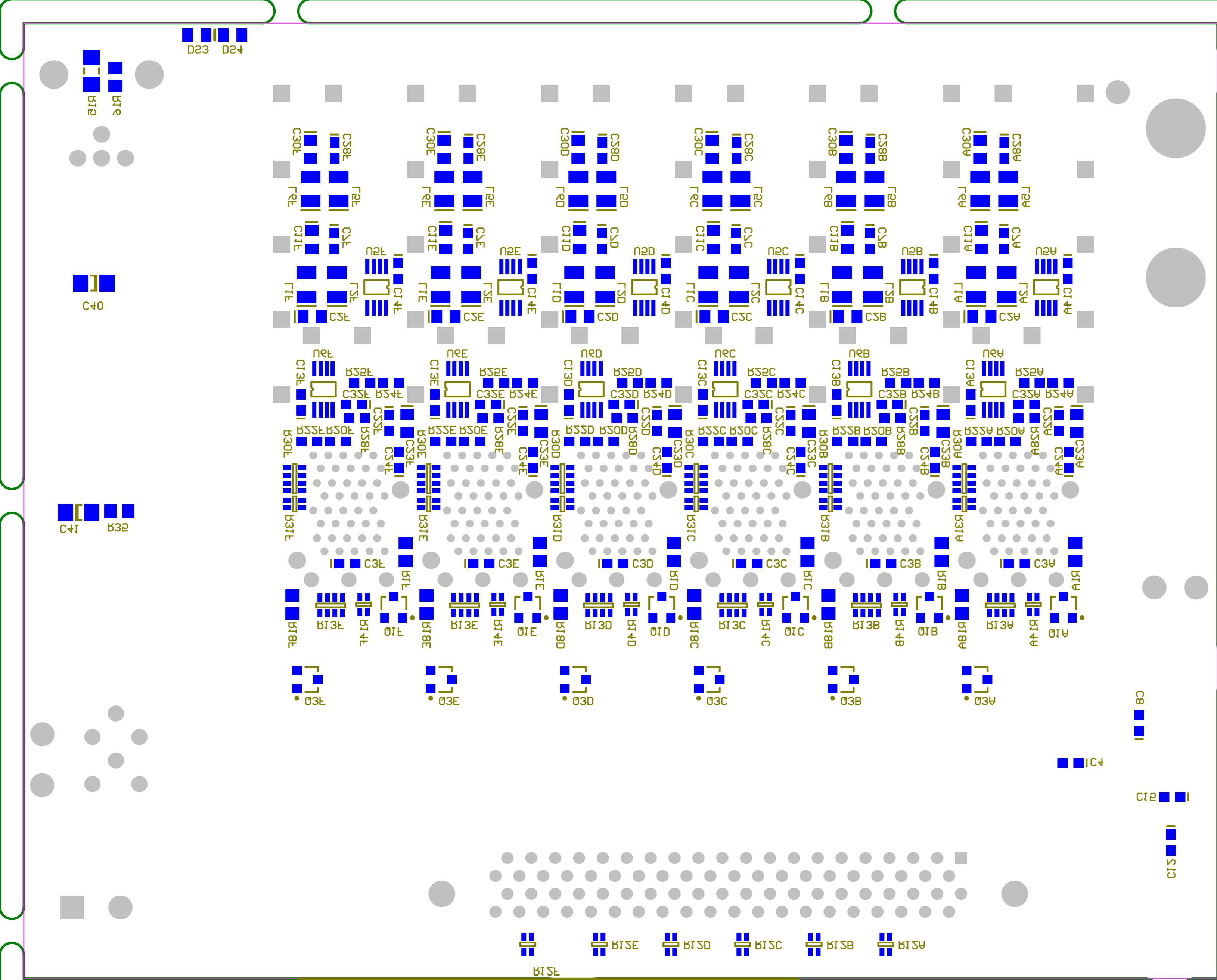


Only stuff one of the header positions





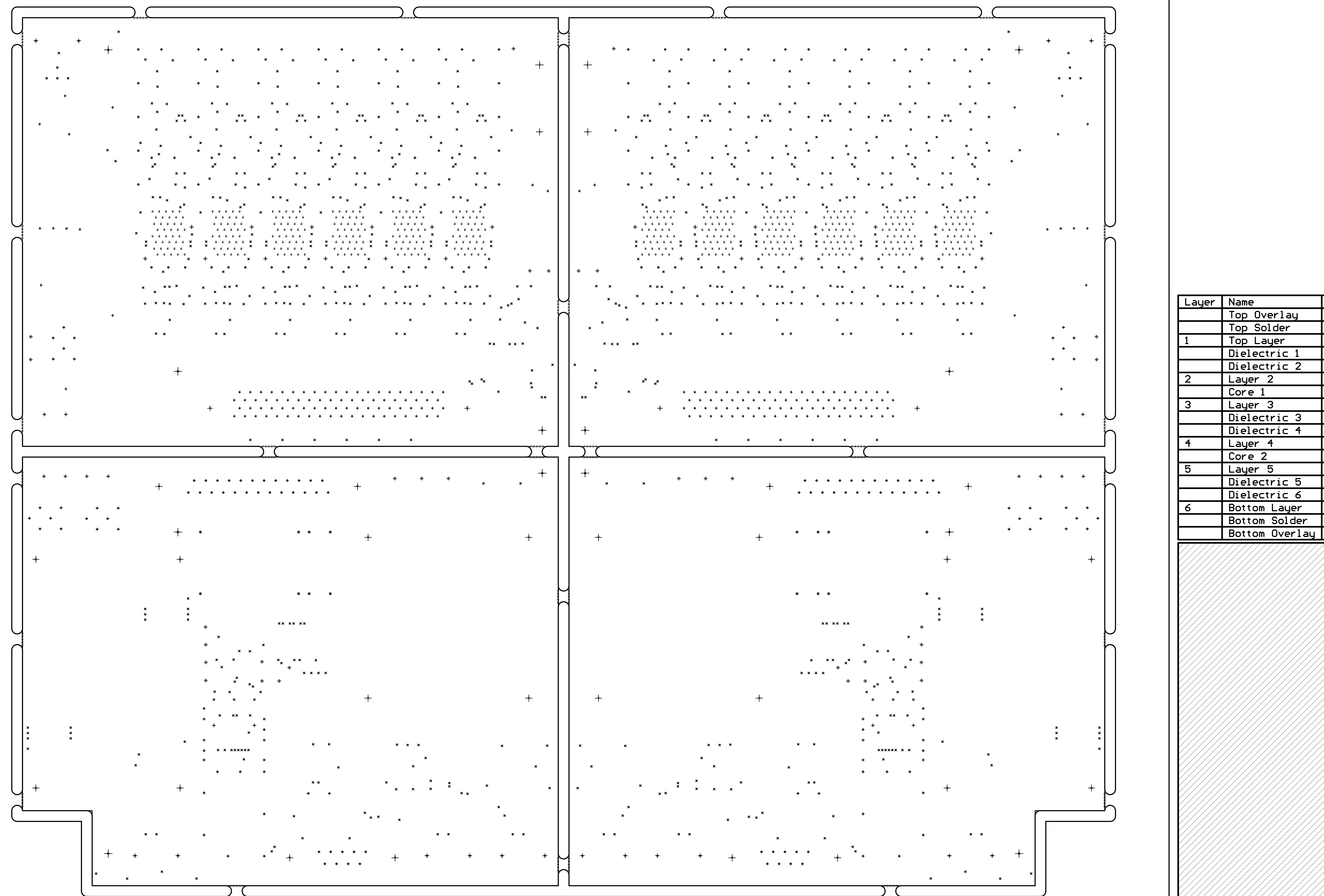
Only this one to be replaced

DS000305

DS000301

OCXO

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template	Description	Hole Tolerance (+)	Hole Tolerance (-)
F	2	130.00mil (3.302mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c635h330			
E	2	150.00mil (3.810mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c635h381			
◇	4	61.02mil (1.550mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c200h155			
A	4	93.00mil (2.362mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c279h236			
I	4	125.00mil (3.175mm)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c318hn318			
⊗	8	124.02mil (3.150mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c500h315			
▽	8	125.00mil (3.175mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c508h318			
∇	8	128.35mil (3.260mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c476h326			
○	12	62.00mil (1.575mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
⊕	12	150.00mil (3.810mm)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c635hn381			
⊞	16	48.00mil (1.219mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c190h122			
⊛	16	80.00mil (2.032mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c305h203			
⊠	18	37.40mil (0.950mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c140h95			
⊡	20	32.00mil (0.813mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c178h81			
D	24	72.84mil (1.850mm)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c185hn185			
G	26	20.00mil (0.508mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v114h51			
□	32	62.21mil (1.580mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c254h158			
⊛	40	47.24mil (1.200mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	<Mixed>			
⊙	68	42.91mil (1.090mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
B	160	35.00mil (0.889mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
⊕	164	41.34mil (1.050mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
H	171	18.00mil (0.457mm)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c46hn46m46			
C	480	18.11mil (0.460mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c82h46			
⊗	874	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v51h25			
	2173 Total										



Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0.40mil	3.5	
1	Top Layer	Copper	1.40mil		
	Dielectric 1	PP-016	4.60mil	4.4	
	Dielectric 2	PP-016	4.60mil	4.4	
2	Layer 2	Copper	1.40mil		
	Core 1	Core-032	14.00mil	4.7	
3	Layer 3	Copper	1.40mil		
	Dielectric 3	PP-016	4.60mil	4.4	
	Dielectric 4	PP-016	4.60mil	4.4	
4	Layer 4	Copper	1.40mil		
	Core 2	Core-032	14.00mil	4.7	
5	Layer 5	Copper	1.40mil		
	Dielectric 5	PP-016	4.60mil	4.4	
	Dielectric 6	PP-016	4.60mil	4.4	
6	Bottom Layer	Copper	1.40mil		
	Bottom Solder	Solder Resist	0.40mil	3.5	
	Bottom Overlay				

